

Taiwan Semiconductor

1A, 200V - 1000V Fast Recovery Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Low power loss, high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- · General purpose

MECHANICAL DATA

- Case: SOD-128
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.027g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
l _F	1	Α		
V _{RRM}	200 - 1000	V		
I _{FSM}	30	Α		
T _J MAX	175	°C		
Package	SOD-128			
Configuration	Single die			









SOD-128



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)							
PARAMETER	SYMBOL	RS1DFS	RS1GFS	RS1JFS	RS1KFS	RS1MFS	UNIT
Marking code on the device		RS1DFS	RS1GFS	RS1JFS	RS1KFS	RS1MFS	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	140	280	420	560	700	V
Forward current	lF	1				Α	
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load	IFSM	30			А		
Junction temperature	TJ	-55 to +175			°C		
Storage temperature	TstG	-55 to +175			°C		



THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-lead thermal resistance	R _{eJL}	29	°C/W		
Junction-to-ambient thermal resistance	Reja	84	°C/W		
Junction-to-case thermal resistance	Rejc	30	°C/W		

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾		I _F = 0.5A, T _J = 25°C		0.94	1.10	V
		I _F = 1.0A, T _J = 25°C	V _F	1.01	1.30	V
		I _F = 0.5A, T _J = 125°C		0.79	1.00	V
		I _F = 1.0A, T _J = 125°C		0.88	1.20	V
Reverse current @ rated $V_R^{(2)}$ Junction capacitance		T _J = 25°C	I _R	-	5	μΑ
		T _J = 125°C		-	50	μA
		1MHz, V _R = 4.0V	СJ	7	-	pF
Reverse recovery time	RS1DFS RS1GFS	I _F = 0.5A, I _R = 1.0A I _{rr} = 0.25A	trr	-	150	ns
	RS1JFS			-	250	ns
	RS1KFS RS1MFS			-	500	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING		
RS1xFS	SOD-128	14,000 / Tape & Reel		

Notes:

1. "x" defines voltage from 200V(RS1DFS) to 1000V(RS1MFS)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

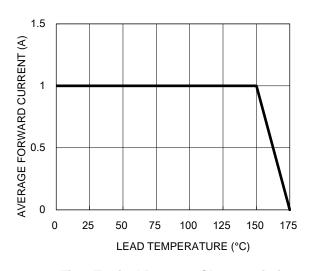


Fig.3 Typical Reverse Characteristics

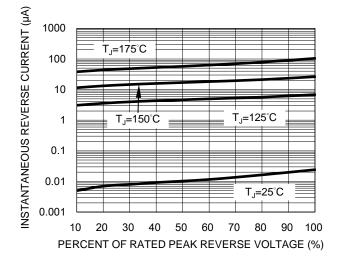


Fig.2 Typical Junction Capacitance

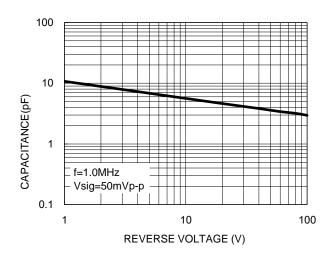
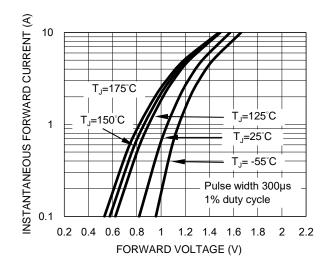


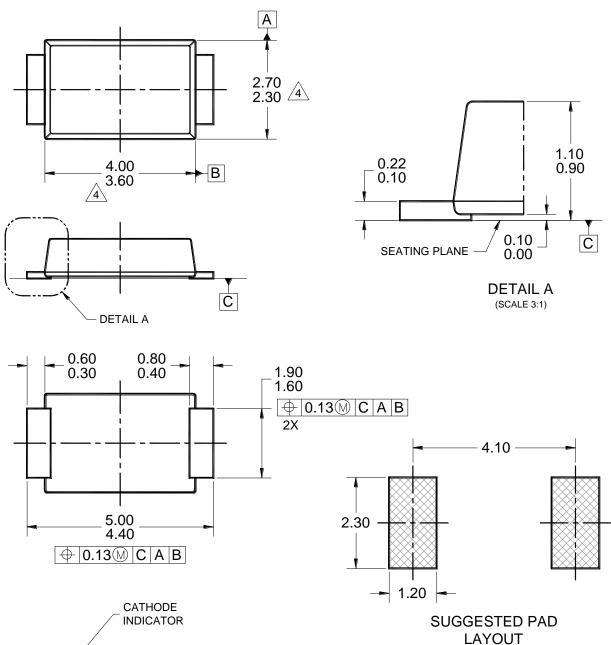
Fig.4 Typical Forward Characteristics

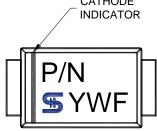




PACKAGE OUTLINE DIMENSIONS

SOD-128





MARKING DIAGRAM

P/N = MARKING CODE YW = DATE CODE

F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-221, VARIATION AD, ISSUE B.
- MODED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- 5. DWG NO. REF: HQ2SD07-SOD128-039 REV A.



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